

Description

The FMXA-1104S is a fast recovery diode of 400 V / 10 A. The maximum t_{rr} of 25 ns is realized by optimizing a life-time control.

Features

•	V _{RM} 400 V	Ţ
•	I _{F(AV)} 10 A	١
•	V _F 1.50 V	Į
•	t _{rr} 25 n	s
	B I IE BIG (B HG G II)	

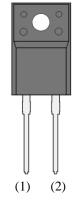
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

- Secondary-side Rectifier Diode (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

TO220F-2L





- (1) Cathode
- (2) Anode

Not to scale

FMXA-1104S

Absolute Maximum Ratings

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		400	V
Repetitive Peak Reverse Voltage	V_{RM}		400	V
Average Forward Current	I _{F(AV)}	See Figure 1 and Figure 2	10	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I ² t Limiting Value	I^2t	$1 \text{ ms} \le t \le 10 \text{ ms}$	50	A^2s
Junction Temperature	T_{J}		-40 to 150	°C
Storage Temperature	T_{STG}		-40 to 150	°C

Electrical Characteristics

Unless otherwise specified, $T_A = 25$ °C.

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
omyond Voltogo Duon	V_{F}	$T_J = 25$ °C, $I_F = 10$ A	_		1.50	V
Forward Voltage Drop		$T_J = 100 ^{\circ}\text{C}, I_F = 10 \text{A}$	_	1.16		V
Reverse Leakage Current	I_R	$V_R = V_{RM}$	_		100	μΑ
Reverse Leakage Current under High Temperature	$H \cdot I_R$	$V_R = V_{RM}, T_J = 150 ^{\circ}C$	_	_	30	mA
Reverse Recovery Time	t _{rr}	$I_F = I_{RP} = 500 \text{ mA},$ 90% recovery point, $T_J = 25 \text{ °C}$	_	_	25	ns
Thermal Resistance ⁽¹⁾	R _{th(J-C)}			_	4.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Тур.	Max.	Unit
Heatsink Mounting Screw Torque		0.490		0.686	N·m

 $^{^{(1)}}R_{th\,(J\text{-}C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

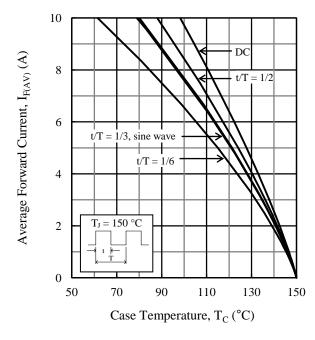


Figure 1. Typical Characteristics: $I_{F(AV)}$ vs. T_{C} ($V_{R}=0\ V$)

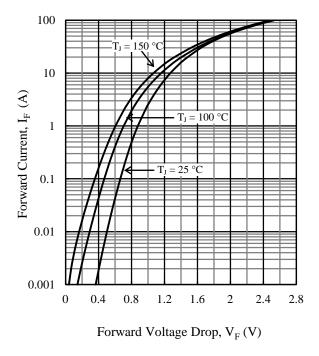


Figure 3. Typical Characteristics: V_F vs. I_F

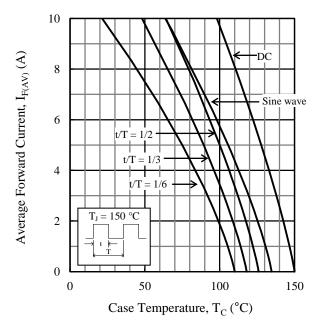


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. T_{C} (V_{R} = 400 V)

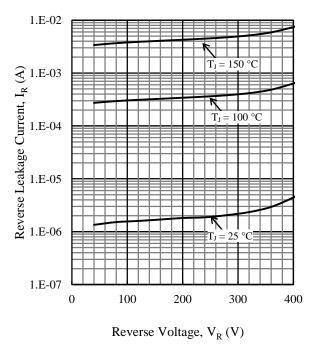
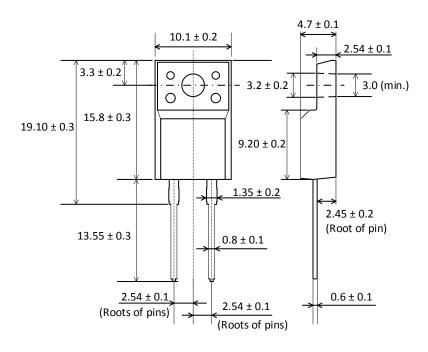


Figure 4. Typical Characteristics: V_R vs. I_R

Physical Dimensions

• TO220F-2L



NOTES:

- Dimensions in millimeters
- All the dimensions exclude mold flashes.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:

Flow: $260 \pm 5 \, ^{\circ}\text{C} / 10 \pm 1 \, \text{s}, \, 2 \, \text{times}$

Soldering Iron: 380 ± 10 °C / 3.5 ± 0.5 s, 1 time

Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram

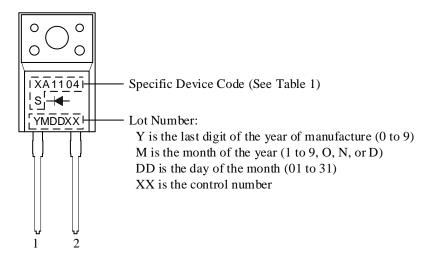


Table 1. Specific Device Code

Specific Device Code	Part Number
XA1104S	FMXA-1104S

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